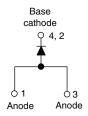


# High Performance Schottky Rectifier, 3.5 A





D-PAK	(TO-252AA)	

PRODUCT SUMMARY					
Package	TO-252AA (D-PAK)				
I <sub>F(AV)</sub>	3.5 A				
V <sub>R</sub>	60 V				
V <sub>F</sub> at I <sub>F</sub>	See Electrical table				
I <sub>RM</sub>	30 mA at 125 °C				
T <sub>J</sub> max.	150 °C				
Diode variation	Single die				
E <sub>AS</sub>	6 mJ				

### **FEATURES**

- Low forward voltage drop
- Guard ring for enhanced ruggedness and long RoHS term reliability



**FREE** 

- Popular D-PAK outline
- · Small foot print, surface mountable
- High frequency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **DESCRIPTION**

The VS-30WQ06FN-M3 surface mount Schottky rectifier has been designed for applications requiring low forward drop and small foot prints on PC board. Typical applications are in disk drives, switching power supplies, converters, freewheeling diodes, battery charging, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES	UNITS			
I <sub>F(AV)</sub>	Rectangular waveform	3.5	Α			
V <sub>RRM</sub>		60	V			
I <sub>FSM</sub>	t <sub>p</sub> = 5 μs sine	490	Α			
V <sub>F</sub>	3 A <sub>pk</sub> , T <sub>J</sub> = 125 °C	0.53	V			
T <sub>J</sub>		-40 to +150	°C			

VOLTAGE RATINGS						
PARAMETER	SYMBOL	VS-30WQ06FN-M3	UNITS			
Maximum DC reverse voltage	$V_R$	60	V			
Maximum working peak reverse voltage	$V_{RWM}$	60	V			

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST COND	ITIONS	VALUES	UNITS	
Maximum average forward current See fig. 5	I <sub>F(AV)</sub>	50 % duty cycle at T <sub>C</sub> = 133 °C	3.5			
Maximum peak one cycle non-repetitive surge current	1	5 μs sine or 3 μs rect. pulse Following any rated load condition and with rated		490	Α	
See fig. 7	IFSM	10 ms sine or 6 ms rect. pulse	V <sub>RRM</sub> applied	70		
Non-repetitive avalanche energy	E <sub>AS</sub>	T <sub>J</sub> = 25 °C, I <sub>AS</sub> = 1 A, L = 12 mH		6.0	mJ	
Repetitive avalanche current	I <sub>AR</sub>	Current decaying linearly to zero in 1 $\mu$ s Frequency limited by T <sub>J</sub> maximum V <sub>A</sub> = 1.5 x V <sub>R</sub> typical		1.0	Α	



ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST COND	DITIONS	VALUES	UNITS	
		3 A	T <sub>J</sub> = 25 °C	0.61	V	
Maximum forward voltage drop	V <sub>FM</sub> <sup>(1)</sup>	6 A	11 = 23 0	0.76		
See fig. 1	VFM (')	3 A	T <sub>.1</sub> = 125 °C	0.53		
		6 A	1 1j = 125 C	0.65		
Maximum reverse leakage current	I <sub>RM</sub> <sup>(1)</sup>	T <sub>J</sub> = 25 °C		2	^	
See fig. 2	IRM (*/	T <sub>J</sub> = 125 °C	V <sub>R</sub> = Rated V <sub>R</sub>	30	mA mA	
Threshold voltage	V <sub>F(TO)</sub>	T T massimum		0.38	V	
Forward slope resistance	r <sub>t</sub>	ij=ijmaximum	$T_J = T_J$ maximum		mΩ	
Typical junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 5 V <sub>DC</sub> (test signal range	145	pF		
Typical series inductance	L <sub>S</sub>	Measured lead to lead 5 mm	from package body	5.0	nH	
Maximum voltage rate of change	dV/dt	Rated V <sub>R</sub>		10 000	V/µs	

#### Note

 $<sup>^{(1)}\,</sup>$  Pulse width < 300 µs, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum junction and storage temperature range	T <sub>J</sub> <sup>(1)</sup> , T <sub>Stg</sub>		-40 to +150	°C		
Maximum thermal resistance, junction to case	R <sub>thJC</sub>	DC operation See fig. 4	4.7	°C/W		
Approximate weight			0.3	g		
Approximate weight			0.01	oz.		
Marking device		Case style D-PAK (similar to TO-252AA)	30WQ(	O6FN		

### Note

$$\frac{dP_{tot}}{dT_J} < \frac{1}{R_{thJA}} \quad \text{thermal runaway condition for a diode on its own heatsink}$$

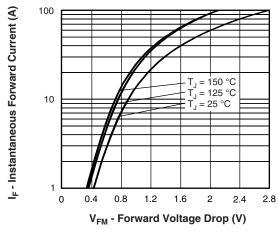


Fig. 1 - Maximum Forward Voltage Drop Characteristics

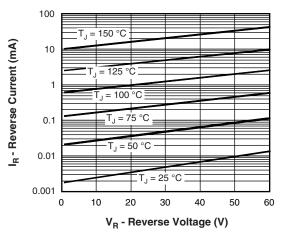


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

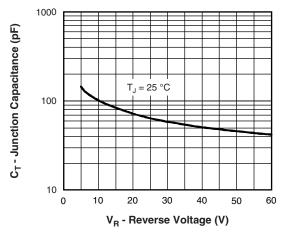


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

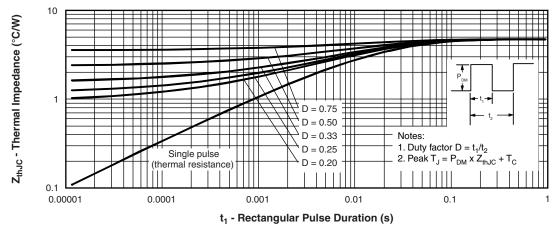


Fig. 4 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics

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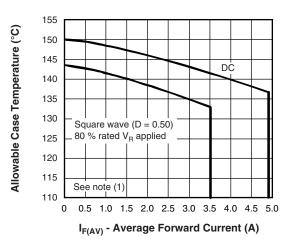


Fig. 5 - Maximum Allowable Case Temperature vs.
Average Forward Current

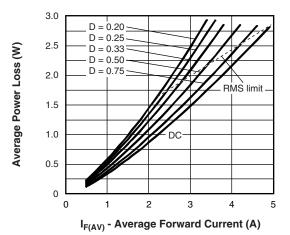
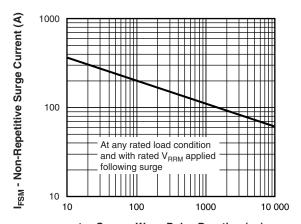


Fig. 6 - Forward Power Loss Characteristics



 $t_{\text{p}}$  - Square Wave Pulse Duration ( $\mu$ s)

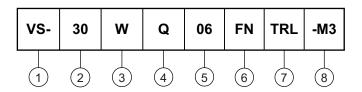
Fig. 7 - Maximum Non-Repetitive Surge Current

## Note



## **ORDERING INFORMATION TABLE**

**Device code** 



1 - Vishay Semiconductors product

Current rating (3.5 A)

Package identifier:

W = D-PAK

4 - Schottky "Q" series

Voltage rating (06 = 60 V)

FN = TO-252AA (D-PAK)

7 - • None = tube

• TR = tape and reel

• TRL = tape and reel (left oriented)

• TRR = tape and reel (right oriented)

8 - Environmental digit:

-M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

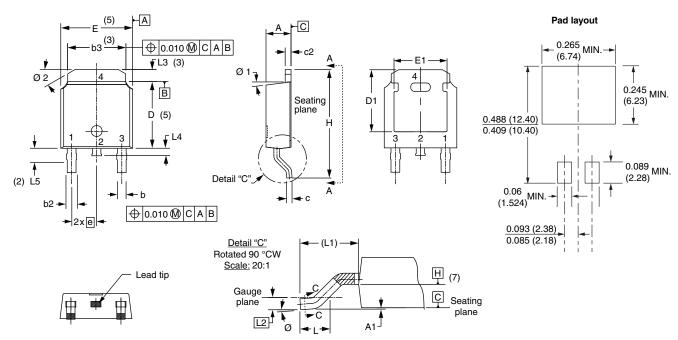
ORDERING INFORMATION (Example)							
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION				
VS-30WQ06FN-M3	75	3000	Antistatic plastic tube				
VS-30WQ06FNTR-M3	2000	2000	13" diameter reel				
VS-30WQ06FNTRL-M3	3000	3000	13" diameter reel				
VS-30WQ06FNTRR-M3	3000	3000	13" diameter reel				

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95627			
Part marking information	www.vishay.com/doc?95176			
Packaging information	www.vishay.com/doc?95033			
SPICE model	www.vishay.com/doc?95687			



# D-PAK (TO-252AA) "M"

### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIN	MILLIMETERS		INCHES	
STIVIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	2.18	2.39	0.086	0.094	
A1	-	0.13	-	0.005	
b	0.64	0.89	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	3
С	0.46	0.61	0.018	0.024	
c2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	5
D1	5.21	-	0.205	-	3
Е	6.35	6.73	0.250	0.265	5
E1	4.32	-	0.170	-	3

SYMBOL	MILLIN	MILLIMETERS		INCHES	
STIMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
е	2.29	BSC	0.090 BSC		
Н	9.40	10.41	0.370	0.410	
L	1.40	1.78	0.055	0.070	
L1	2.74 BSC		0.108 REF.		
L2	0.51 BSC		0.020 BSC		
L3	0.89	1.27	0.035	0.050	3
L4	-	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	2
Ø	0°	10°	0°	10°	
Ø1	0°	15°	0°	15°	
Ø2	25°	35°	25°	35°	

#### Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension uncontrolled in L5
- (3) Dimension D1, E1, L3 and b3 establish a minimum mounting surface for thermal pad
- (4) Section C C dimension apply to the flat section of the lead between 0.13 and 0.25 mm (0.005 and 0.10") from the lead tip
- (5) Dimension D, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (6) Dimension b1 and c1 applied to base metal only
- (7) Datum A and B to be determined at datum plane H
- (8) Outline conforms to JEDEC® outline TO-252AA

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